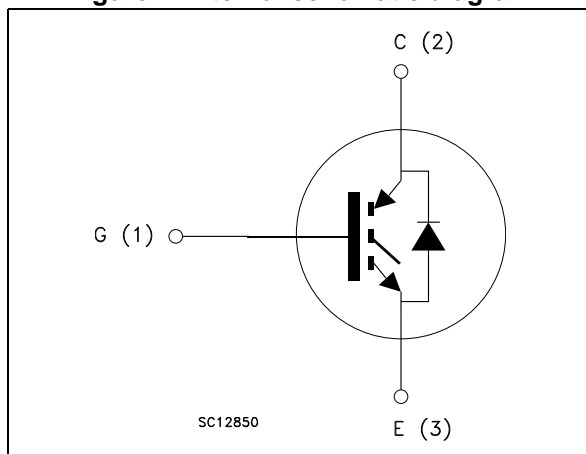


Figure 1. Internal schematic diagram



Features

- Designed for soft commutation only
- Maximum junction temperature: $T_J = 175\text{ }^\circ\text{C}$
- Minimized tail current
- Low saturation voltage: $V_{CE(sat)} = 2.0\text{ V (typ.)}$ @ $I_C = 15\text{ A}$
- Tight parameters distribution
- Safe paralleling
- Low V_F soft recovery co-packaged diode
- Low thermal resistance
- Lead free package

Applications

- Induction heating
- Microwave oven
- Resonant converters

Description

These IGBTs are developed using an advanced proprietary trench gate field-stop structure and performance is optimized in both conduction and switching losses. A freewheeling diode with a low drop forward voltage is co-packaged. The result is a product specifically designed to maximize efficiency for any resonant and soft-switching application.

Table 1. Device summary

Order code	Marking	Package	Packaging
STGW18IH120DF	GW18IH120DF	TO-247	Tube
STGWT18IH120DF	GWT18IH120DF	TO-3P	Tube

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-emitter voltage ($V_{GE} = 0$)	1200	V
I_C	Continuous collector current at $T_C = 25\text{ °C}$	30	A
I_C	Continuous collector current at $T_C = 100\text{ °C}$	15	A
$I_{CP}^{(1)}$	Pulsed collector current	60	A
V_{GE}	Gate-emitter voltage	± 20	V
I_F	Continuous forward current at $T_C = 25\text{ °C}$	30	A
I_F	Continuous forward current at $T_C = 100\text{ °C}$	15	A
$I_{FP}^{(1)}$	Pulsed forward current	60	A
P_{TOT}	Total dissipation at $T_C = 25\text{ °C}$	259	W
T_{STG}	Storage temperature range	- 55 to 150	°C
T_J	Operating junction temperature	- 40 to 175	°C

1. Pulse width limited by maximum junction temperature and turn-off within RBSOA

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Thermal resistance junction-case IGBT	0.58	°C/W
R_{thJC}	Thermal resistance junction-case diode	1.47	°C/W
R_{thJA}	Thermal resistance junction-ambient	50	°C/W

2 Electrical characteristics

$T_J = 25\text{ °C}$ unless otherwise specified.

Table 4. Static characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage ($V_{GE} = 0$)	$I_C = 2\text{ mA}$	1200			V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$V_{GE} = 15\text{ V}, I_C = 15\text{ A}$		2		V
		$V_{GE} = 15\text{ V}, I_C = 15\text{ A}$ $T_J = 125\text{ °C}$		2.25		
		$V_{GE} = 15\text{ V}, I_C = 15\text{ A}$ $T_J = 175\text{ °C}$		2.35		
		$V_{GE} = 15\text{ V}, I_C = 30\text{ A}$		2.55		
V_F	Forward on-voltage	$I_F = 25\text{ A}$		1.3		V
		$I_F = 25\text{ A } T_J = 125\text{ °C}$		TBD		V
		$I_F = 25\text{ A } T_J = 175\text{ °C}$		TBD		V
$V_{GE(th)}$	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 1\text{ mA}$		5.5		V
I_{CES}	Collector cut-off current ($V_{GE} = 0$)	$V_{CE} = 1200\text{ V}$			250	μA
I_{GES}	Gate-emitter leakage current ($V_{CE} = 0$)	$V_{GE} = \pm 20\text{ V}$			250	nA

Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{ies}	Input capacitance	$V_{CE} = 25\text{ V}, f = 1\text{ MHz},$ $V_{GE} = 0$	-	2150	-	pF
C_{oes}	Output capacitance		-	80	-	pF
C_{res}	Reverse transfer capacitance		-	10	-	pF
Q_g	Total gate charge	$V_{CC} = 600\text{ V}, I_C = 15\text{ A},$ $V_{GE} = 15\text{ V},$ see Figure 4	-	49	-	nC
Q_{ge}	Gate-emitter charge		-	15	-	nC
Q_{gc}	Gate-collector charge		-	13	-	nC

Table 6. IGBT switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(off)}$	Turn-off delay time	$V_{CE} = 600\text{ V}$, $I_C = 15\text{ A}$, $R_G = 22\ \Omega$, $V_{GE} = 15\text{ V}$, see Figure 2		TBD		ns
t_f	Current fall time		-	TBD	-	ns
$E_{off}^{(1)}$	Turn-off switching losses		-	0.51	-	μJ
$t_{d(off)}$	Turn-off delay time	$V_{CE} = 600\text{ V}$, $I_C = 15\text{ A}$, $R_G = 22\ \Omega$, $V_{GE} = 15\text{ V}$, $T_J = 175\text{ }^\circ\text{C}$, see Figure 2		TBD		ns
t_f	Current fall time		-	TBD	-	ns
$E_{off}^{(1)}$	Turn-off switching losses		-	0.95	-	μJ

1. Turn-off losses include also the tail of the collector current.

Table 7. IGBT switching characteristics (capacitive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$E_{off}^{(1)}$	Turn-off switching losses	$V_{CC} = 900\text{ V}$, $R_G = 10\ \Omega$, $I_C = 30\text{ A}$, $L = 500\ \mu\text{H}$, $C_{snub} = 300\text{ nF}$, see Figure 3	-	85	-	μJ
		$V_{CC} = 900\text{ V}$, $R_G = 10\ \Omega$, $I_C = 30\text{ A}$, $L = 500\ \mu\text{H}$, $C_{snub} = 300\text{ nF}$, $T_J = 175\text{ }^\circ\text{C}$, see Figure 3	-	140	-	

1. Turn-off losses include also the tail of the collector current.

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 8. TO-247 mechanical data

Dim.	mm.		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

Figure 6. TO-247 drawing

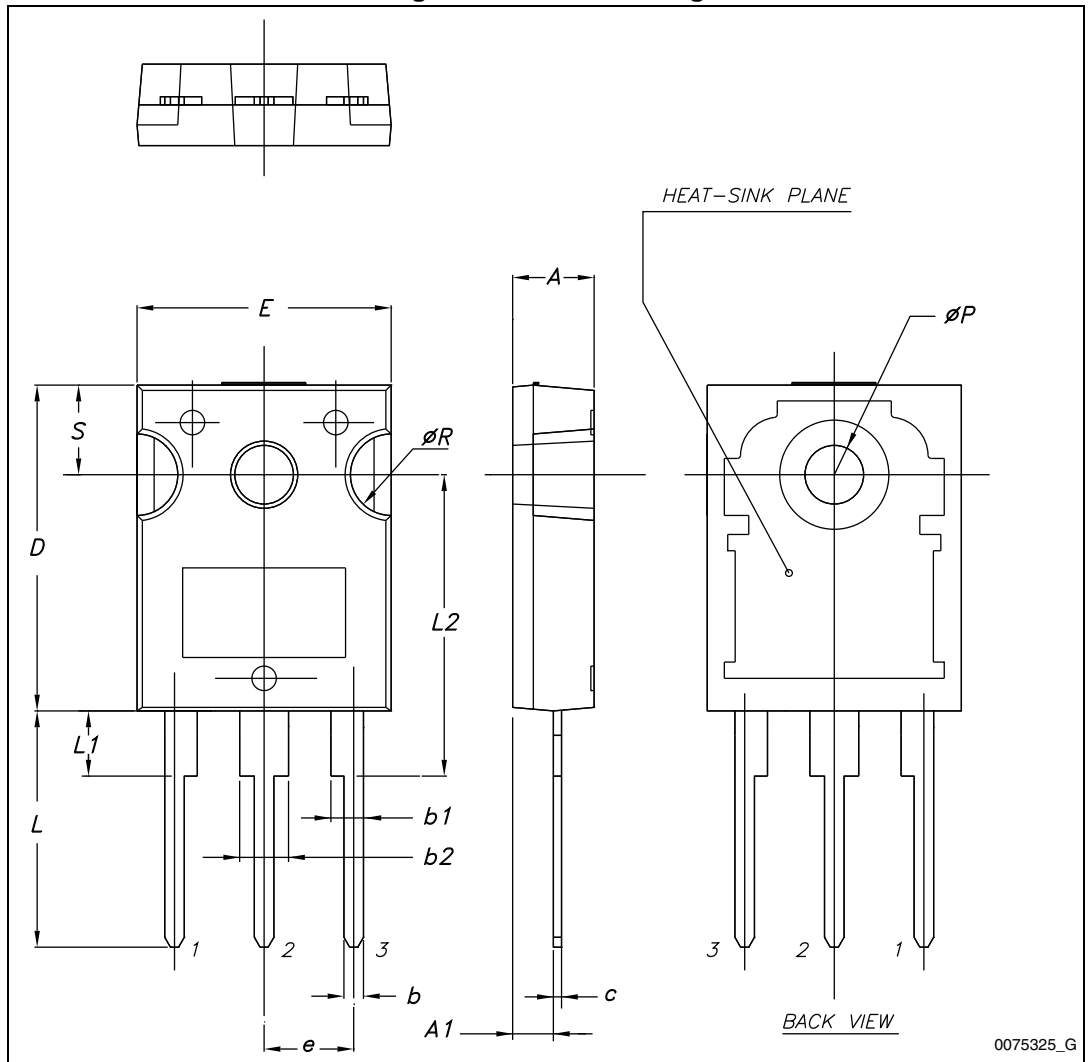
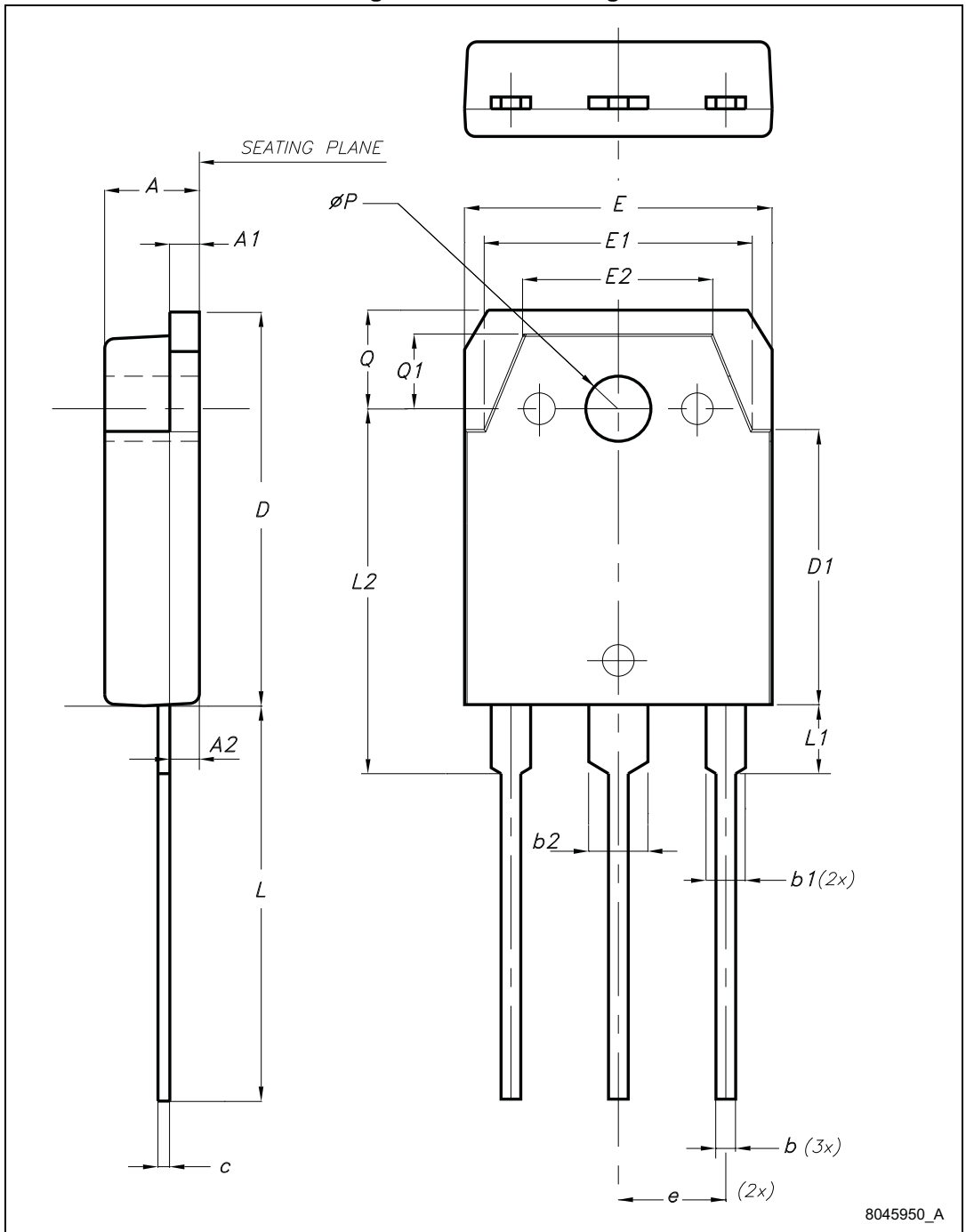


Table 9. TO-3P mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.60		5
A1	1.45	1.50	1.65
A2	1.20	1.40	1.60
b	0.80	1	1.20
b1	1.80		2.20
b2	2.80		3.20
c	0.55	0.60	0.75
D	19.70	19.90	20.10
D1		13.90	
E	15.40		15.80
E1		13.60	
E2		9.60	
e	5.15	5.45	5.75
L	19.50	20	20.50
L1		3.50	
L2	18.20	18.40	18.60
øP	3.10		3.30
Q		5	
Q1		3.80	

Figure 7. TO-3P drawing



8045950_A

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
14-Mar-2013	1	Initial release.

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